

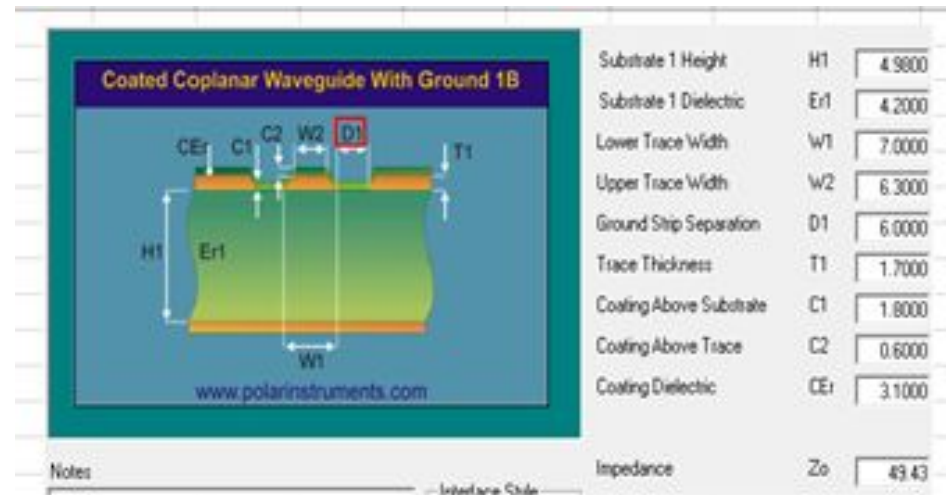
Forever Connected, Anywhere.



ATM3-MOD-A_PCB Structure

Impedance Simulation

- Layer Count: 4 LAYERS
- Board Thickness: 0.8mm +/- 0.1mm
- Copper Weight: outlayer 1.0oz
- Dielectric Constant: 4.3 FR4



PCB Stackup

PCB STACK UP 4-layer			
		Layer Name	Thickness 0.8 mm
	SM		0.6
TOP	L1	1/2 oz+plating	1.7
		PP:2116	4.98
GND	L2	1oz	1.2
		core: 15mil	15
GND	L3	1oz	1.2
		PP:2116	4.98
BOT	L4	1/2 oz+plating	1.7
	SM		0.6
		板厚	31.96